

PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TIM HOLME	10/13/2016
SRIRAM IYER	10/12/2016
NIALL DONNELLY	10/12/2016
RECEIVING PARTY DATA	
Name:	QUANTUMSCAPE CORPORATION
Street Address:	1730 TECHNOLOGY DRIVE
City:	SAN JOSE
State/Country:	CALIFORNIA
Postal Code:	95110
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15787623
CORRESPONDENCE DATA	
Fax Number:	(415)393-9887
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	4159540200
Email:	linda.brost@squirepb.com, sfripdocket@squirepb.com
Correspondent Name:	SQUIRE PATTON BOGGS (US) LLP
Address Line 1:	275 BATTERY STREET, SUITE 2600
Address Line 4:	SAN FRANCISCO, CALIFORNIA 94111-3492
ATTORNEY DOCKET NUMBER:	114826.00293
NAME OF SUBMITTER:	TODD A. OSTOMEL
SIGNATURE:	/ToddOstomelReg63426/
DATE SIGNED:	01/07/2020
Total Attachments: 3	
source=114826.00293 Assignments from .00238 for Recordation - Holme, Iyer, Donnelly#page1.tif	
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source=114826.00293 Assignments from .00238 for Recordation - Holme, Iyer, Donnelly#page3.tif	

ASSIGNMENT

WHEREAS, I, **Tim HOLME**, ASSIGNOR, citizen of the United States, with a mailing address at c/o QuantumScape Corporation, 1730 Technology Drive, San Jose, California, 95110, in relation to the invention for which an application for patent has been filed on **October 5, 2016** as U.S. Application No. **15/286,509** (Docket No. 114826.00238), entitled **LITHIUM STUFFED GARNET SETTER PLATES FOR SOLID ELECTROLYTE FABRICATION**,

and WHEREAS, **QuantumScape Corporation**, a corporation organized and existing under the laws of the state of Delaware, and having an office for the transaction of business at 1730 Technology Drive, San Jose, California, 95110, herein referred to as "ASSIGNEE", is desirous of obtaining my entire right, title and interest in, to and under the said invention and the said application.


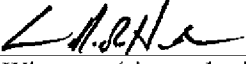
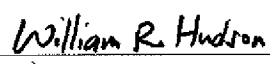
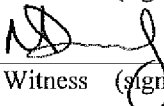
NOW, THEREFORE, in consideration of good and valuable consideration, the receipt of which is hereby acknowledged, I, the said ASSIGNOR, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, my entire right, title and interest in, to and under the said invention, and the said application and all applications claiming priority thereto and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof;

AND I HEREBY authorize and request the Commissioner for Patents and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument;

AND I HEREBY covenant and agree that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith;

AND I HEREBY further covenant and agree that I will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.

IN TESTIMONY WHEREOF, I hereunto set my hand and seal the day and year set opposite my respective signature.

Date <u>10-13-16</u>	 _____ Tim HOLME	L.S.
Date <u>10/13/2016</u>	  _____ Witness (sign and print name) William R. Hudson	
Date <u>10/13/16</u>	 _____ Witness (sign and print name) NIALL DONNELLY.	

ASSIGNMENT

WHEREAS, I, Sriram IYER, ASSIGNOR, citizen of India, with a mailing address at c/o QuantumScape Corporation, 1730 Technology Drive, San Jose, California, 95110, in relation to the invention for which an application for patent has been filed on October 5, 2016 as U.S. Application No. 15/286,509 (Docket No. 114826.00238), entitled LITHIUM STUFFED GARNET SETTER PLATES FOR SOLID ELECTROLYTE FABRICATION,

and WHEREAS, QuantumScape Corporation, a corporation organized and existing under the laws of the state of Delaware, and having an office for the transaction of business at 1730 Technology Drive, San Jose, California, 95110, herein referred to as "ASSIGNEE", is desirous of obtaining my entire right, title and interest in, to and under the said invention and the said application.

NOW, THEREFORE, in consideration of good and valuable consideration, the receipt of which is hereby acknowledged, I, the said ASSIGNOR, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, my entire right, title and interest in, to and under the said invention, and the said application and all applications claiming priority thereto and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof;

AND I HEREBY authorize and request the Commissioner for Patents and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument;

AND I HEREBY covenant and agree that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith;

AND I HEREBY further covenant and agree that I will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.

IN TESTIMONY WHEREOF, I hereunto set my hand and seal the day and year set opposite my respective signature.

Date 10/12/2016

[Signature]
Sriram IYER L.S.

Date 10/12/16

[Signature] KIM VAN BERKEL
Witness (sign and print name)

Date 10/12/16

[Signature]
Witness (sign and print name)

ASSIGNMENT

WHEREAS, I, Niall DONNELLY, ASSIGNOR, citizen of the United Kingdom, with a mailing address at c/o QuantumScape Corporation, 1730 Technology Drive, San Jose, California, 95110, in relation to the invention for which an application for patent has been filed on October 5, 2016 as U.S. Application No. 15/286,509 (Docket No. 114826.00238), entitled LITHIUM STUFFED GARNET SETTER PLATES FOR SOLID ELECTROLYTE FABRICATION,

and WHEREAS, QuantumScape Corporation, a corporation organized and existing under the laws of the state of Delaware, and having an office for the transaction of business at 1730 Technology Drive, San Jose, California, 95110, herein referred to as "ASSIGNEE", is desirous of obtaining my entire right, title and interest in, to and under the said invention and the said application.

NOW, THEREFORE, in consideration of good and valuable consideration, the receipt of which is hereby acknowledged, I, the said ASSIGNOR, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, my entire right, title and interest in, to and under the said invention, and the said application and all applications claiming priority thereto and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof;

AND I HEREBY authorize and request the Commissioner for Patents and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument;

AND I HEREBY covenant and agree that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith;


AND I HEREBY further covenant and agree that I will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.

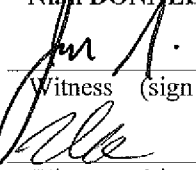
IN TESTIMONY WHEREOF, I hereunto set my hand and seal the day and year set opposite my respective signature.

Date 10/12/16 _____

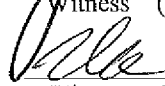
Date 10/12/16 _____

Date 10/12/16 _____


 _____ L.S.
 Niall DONNELLY

 JOSEPH SALVI

 Witness (sign and print name)

 Hiro Oba

 Witness (sign and print name)